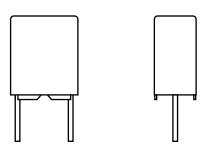


DC Film Capacitors MKT Radial Potted Type



FEATURES

- 5.08 mm lead pitch
- Supplied loose in box, taped on ammopack or reel



 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





RoHS COMPLIANT

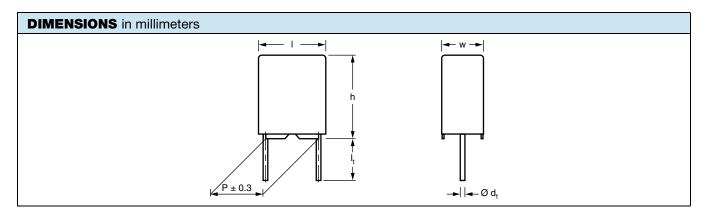
APPLICATIONS

Blocking and coupling, bypass and energy reservoir, telecom, industrial, consumer.

QUICK REFERENCE DATA				
Capacitance range (E12 series)	0.00068 μF to 1.5 μF			
Capacitance tolerance	± 10 %, ± 5 %			
Rated DC voltage	50 V, 63 V, 250 V, 400 V, 630 V			
Rated AC voltage	32 V, 40 V, 63 V, 160 V, 220 V			
Climatic testing class acc. to IEC 60068-1	55/100/56 for rated voltage 50 V and 63 V 55/105/56 for rated voltage > 63 V			
Maximum application temperature	100 °C for rated voltage 50 V and 63 V 105 °C for rated voltage > 63 V			
Rated temperature	85 °C			
Reference standards	IEC 60384-2			
Dielectric	Polyester film			
Electrodes	Metallized			
	Mono construction			
Construction	Triple construction for 630 V, 0.00068 μF to 0.0018 μF			
Encapsulation	Flame retardant plastic case and epoxy resin (UL-class 94 V-0)			
Leads	Tinned wire			
Marking	C-value; tolerance; rated voltage; manufacturer's symbol; year and week of manufacture; manufacturer's type			
Performance grade Grade 1 (long life)				

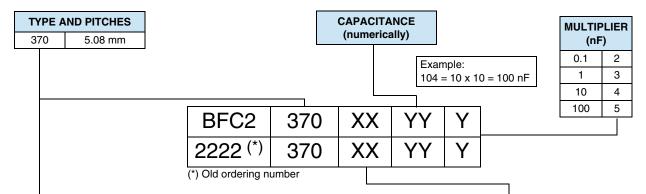
Note

• For more detailed data and test requirements, contact dc-film@vishay.com





COMPOSITION OF CATALOG NUMBER



TYPE	PACKAGING	LEAD CONFIGURATION	PREFERRED TYPES						
ITFE	PACKAGING	LEAD CONFIGURATION	C-TOL.	63 V	100 V	250 V	400 V		
		Lead length	± 10 %	11	21	41	51		
	Loose in box	4.0 mm + 1.0 mm/- 0.5 mm	±5%	12	22	42	52		
	Loose III box	Lead length 26.0 mm ± 2.0 mm	± 10 %	15	25	45	55		
370		Lead length 20.0 mm ± 2.0 mm	±5%	16	26	46	56		
(standard size)	Taped on reel (1)	$H = 18.5 \text{ mm}$; $P_0 = 12.7 \text{ mm}$;	± 10 %	18	28	48	58		
	Taped of Teel (7	Reel diameter = 356 mm	±5%	19	29	49	59		
	Ammopack (2)	$H = 18.5 \text{ mm}$; $P_0 = 12.7 \text{ mm}$	± 10 %	75	85	35	65		
	Ammopack	$T = 10.5 \text{ Him}, F_0 = 12.7 \text{ Him}$	±5%	76	86	36	66		

TYPE	PACKAGING	LEAD CONFIGURATION	PREFERRED TYPES						
ITPE	PACKAGING	LEAD CONFIGURATION	C-TOL.	100 V	250 V	400 V	630 V		
		Lead length	± 10 %	CE	EE	FE	GE		
	Loose in box	4.0 mm + 1.0 mm/- 0.5 mm	±5%	CF	EF	FF	GF		
	Loose III box	Lead length 26.0 mm ± 2.0 mm	± 10 %	CH	EH	FH	GH		
370		Lead length 20.0 mm ± 2.0 mm	±5%	CI	EI	FI	GI		
(compact size)	Taped on reel (1)	$H = 18.5 \text{ mm}$; $P_0 = 12.7 \text{ mm}$;	± 10 %	CL	EL	FL	GL		
	Taped of Teel (1)	Reel diameter = 356 mm	±5%	CM	EM	FM	GM		
	Ammopack (2)	$H = 18.5 \text{ mm}$; $P_0 = 12.7 \text{ mm}$	± 10 %	CB	EB	FB	GB		
	Ammopack (=)	11 = 16.5 mm, F ₀ = 12.7 mm	±5%	CC	EC	FC	GC		

Notes

- For detailed tape specifications refer to packaging information: www.vishay.com/doc?28139 or end of catalog
- (1) Reel diameter = 356 mm is available on request
- (2) H = in-tape height; P₀ = sprocket hole distance; for detailed specifications refer to packaging information



SPECIFIC REFERENCE DATA (Standard Size)						
DESCRIPTION	VALUE					
Tangent of loss angle:	at 1	kHz	at 10 kHz	at 100 kHz		
C ≤ 0.1 µF	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	≤ 220 x 10 ⁻⁴		
$0.1 \ \mu F < C \le 0.47 \ \mu F$	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	≤ 300 x 10 ⁻⁴		
$0.47 \ \mu F < C \le 1.5 \ \mu F$	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	-		
Rated voltage pulse slope (dU/dt) _R at	50 V _{DC} /63 V _{DC}	100 V _{DC}	250 V _{DC}	400 V _{DC}		
nated voltage pulse slope (do/dt/jR at	60 V/μs	110 V/μs	330 V/µs	630 V/µs		
R between leads, for C \leq 0.33 μF						
at 10 V; 1 min	$>$ 15 000 M Ω					
at 100 V; 1 min		> 15 000 MΩ	> 30 000 MΩ	$>$ 30 000 M Ω		
RC between leads						
$0.33~\mu F < C \le 1.0~\mu F$ at 10 V; 1 min	> 5000 s					
$C > 1.0 \mu F$ at 10 V; 1 min	> 1000 s					
C > 0.33 µF at 100 V; 1 min		> 5000 s				
R between interconnecting leads and case (foil method)	> 30 000 MΩ	$>$ 30 000 M Ω	> 30 000 MΩ	> 30 000 MΩ		
Withstanding (DC) voltage (cut off current 10 mA) $^{(1)}$; rise time \leq 1000 V/s rise time 100 V/s	100 V; 1 min	160 V; 1 min	400 V; 1 min	640 V; 1 min		
Withstanding (DC) voltage between leads and case	200 V; 1 min	200 V; 1 min	500 V; 1 min	800 V; 1 min		
Maximum application temperature	100 °C		105 °C			

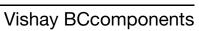
Note

⁽¹⁾ See "Voltage Proof Test for Metallized Film Capacitors": www.vishay.com/doc?28169

SPECIFIC REFERENCE DATA (Compact Size)					
DESCRIPTION	VALUE				
Tangent of loss angle:	at 1	kHz	at 10 kHz	at 100 kHz	
C ≤ 0.1 µF	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	≤ 220 x 10 ⁻⁴	
$0.1 \ \mu F < C \le 0.47 \ \mu F$	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	≤ 300 x 10 ⁻⁴	
$C > 0.47 \mu F$	≤ 75 :	x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	-	
Detect violage pulse close (dl 1/dt) et	100 V _{DC}	250 V _{DC}	400 V _{DC}	630 V _{DC}	
Rated voltage pulse slope (dU/dt) _R at	37 V/µs	44 V/µs	200 V/μs	540 V/μs	
R between leads, for C \leq 0.33 μF					
at 100 V; 1 min	$>$ 15 000 M Ω	> 30 000 MΩ	> 30 000 MΩ	> 30 000 MΩ	
RC between leads					
C > 0.33 µF at 100 V; 1 min	> 5000 s				
R between interconnecting leads and case (foil method)	> 30 000 MΩ	> 30 000 MΩ	> 30 000 MΩ	> 30 000 MΩ	
Withstanding (DC) voltage (cut off current 10 mA) $^{(1)}\!;$ rise time \leq 1000 V/s rise time 100 V/s	160 V; 1 min	400 V; 1 min	640 V; 1 min	1008 V; 1 min	
Withstanding (DC) voltage between leads and case	200 V; 1 min	500 V; 1 min	800 V; 1 min	1260 V; 1 min	
Maximum application temperature	100 °C		105 °C		

Note

⁽¹⁾ See "Voltage Proof Test for Metallized Film Capacitors": www.vishay.com/doc?28169





50 0 0 0 0	1.2 1.5 0.056 0.068 0.082 0.10 0.12	DIMENSIONS wxhxl (mm)	0.64	H = 18 P ₀ = 12 C-TOL. = ± 10 % XX (SPQ) RAC = 32 V 75 (750)	DPACK .5 mm; 2.7 mm C-TOL. = ± 5 % XX (SPQ) PITCH = 5	SHORT	LOOSE LEADS C-TOL. = ± 5 %	LONG C-TOL. =		PACKAGIN RE		C-VALUE	
50 0 0 0 0	1.2 1.5 0.056 0.068 0.082 0.10	w x h x l (mm)	(g) ⁽¹⁾ U 0.64	H = 18 P ₀ = 12 C-TOL. = ± 10 % XX (SPQ) RAC = 32 V 75 (750)	.5 mm; 2.7 mm C-TOL. = ± 5 % XX (SPQ) PITCH = 5	C-TOL. = ± 10 % XX	LEADS C-TOL. =	LONG C-TOL. =	1	KE	<u>EL</u>	C-VALUE	
50	1.2 1.5 0.056 0.068 0.082 0.10	(mm) 6.0 x 11.0 x 7.2	U 0.64	C-TOL. = ± 10 % XX (SPQ) RAC = 32 V; 75 (750)	C-TOL. = ± 5 % XX (SPQ) PITCH = 5	± 10 %			C TOI				
0 0	1.5 0.056 0.068 0.082 0.10		0.64	(SPQ) RAC = 32 V; 75 (750)	(SPQ) PITCH = 5			± 10 %	± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %		
0 0	1.5 0.056 0.068 0.082 0.10		0.64	75 (750)			XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	YYY	
0 0	1.5 0.056 0.068 0.082 0.10			(750)									
0	0.068 0.082 0.10	0.5 x 6.5 x 7.0	<u>_</u>	40 1/	(750)	(2000)	(2000)	(1000)	(1000)	(1000)	19 (1000)	125 155	
(0.15 0.18	2.5 x 6.5 x 7.2	0.18	75 (2000)	76 (2000)	11 (2000)	12 (2000)	15 (1000)	16 (1000)	18 (2000)	19 (2000)	563 683 823 104 124 154 184	
0	0.22 0.27 0.33 0.39 0.47	3.5 x 8.0 x 7.2	0.3	75 (1500)	76 (1500)	11 (2000)	12 (2000)	15 (1000)	16 (1000)	18 (1500)	19 (1500)	224 274 334 394 474	
C	0.56 0.68	4.5 x 9.0 x 7.2	0.42	75 (1000)	76 (1000)	11 (2000)	12 (2000)	15 (1000)	16 (1000)	18 (1000)	19 (1000)	564 684	
	0.82 1.0	6.0 x 11.0 x 7.2	0.64	75 (750)	76 (750) PITCH = 5	(2000)	12 (2000)	15 (1000)	16 (1000)	18 (1000)	19 (1000)	824 105	
0. 0. 0. 0. 0. 0. 0. 0. 0. 0. 0. 0. 0. 0	.0010 .0012 .0015 .0018 .0022 .0027 .0033 .0039 .0047 .0056 .0068 .0082 .010 .012 .015 .015 .015 .027 .033 .039 .0047 .033 .039 .0047 .0056 .0068 .0082	2.5 x 6.5 x 7.2	0.18	85 (2000)	86 (2000)	21 (2000)	22 (2000)	25 (1000)	26 (1000)	28 (2000)	29 (2000)	102 122 152 182 222 272 332 392 472 562 682 822 103 123 153 183 223 273 333 393 473 563 683 823 104	
0	0.12 0.15 0.18 0.22	3.5 x 8.0 x 7.2	0.30	85 (1500)	86 (1500)	21 (2000) 21	22 (2000) 22	25 (1000) 25	26 (1000) 26	28 (1500) 28	29 (1500) 29	124 154 184 224	
C	0.27 0.33 0.39 0.47	4.5 x 9.0 x 7.2 6.0 x 11.0 x 7.2	0.42	(1000) 85 (750)	(1000) 86 (750)	(2000) 21 (2000)	(2000) 22 (2000)	(1000) 25 (1000)	(1000) 26 (1000)	(1000) 28 (1000)	(1000) 29 (1000)	274 334 394 474	



ELI	ECTR	ICAL DATA A	ND O	RDERIN	G INFOF	RMATIO	N (Standa	ard Size)				
						ATALOG N			CYYY AND			
					PACK		LOOSE	IN BOX		RE	EL	
U _{RDC}	CAP.	DIMENSIONS wxhxl	MASS	$P_0 = 12$.5 mm; 2.7 mm		LEADS	LONG	LEADS		T	C-VALUE
(V)	(µF)	(mm)	(g) ⁽¹⁾	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	
				XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	YYY
			U	RAC = 160 V	; PITCH =	5.08 mm ±	0.30 mm;	d _t = 0.50 m	m ± 0.05 m	m		
250	0.0010 0.0012 0.0015 0.0018 0.0022 0.0027 0.0033 0.0039 0.0047 0.0056 0.0068 0.0082 0.010 0.012 0.015 0.018	2.5 x 6.5 x 7.2	0.18	35 (2000)	36 (2000)	41 (2000)	42 (2000)	45 (1000)	46 (1000)	48 (2000)	49 (2000)	102 122 152 182 222 272 332 392 472 562 682 822 103 123 153 183
	0.022 0.027 0.033	3.5 x 8.0 x 7.2	0.30	35 (1500)	36 (1500)	41 (2000)	42 (2000)	45 (1000)	46 (1000)	48 (1500)	49 (1500)	223 273 333
	0.039 0.047 0.056	4.5 x 9.0 x 7.2	0.42	35 (1000)	36 (1000)	41 (2000)	42 (2000)	45 (1000)	46 (1000)	48 (1000)	49 (1000)	393 473 563
	0.068 0.082 0.10	6.0 x 11.0 x 7.2	0.64	35 (750)	36 (750)	41 (2000)	42 (2000)	45 (1000)	46 (1000)	48 (1000)	49 (1000)	683 823 104
			U	_{RAC} = 220 V	; PITCH =	5.08 mm ±	0.30 mm;	d _t = 0.50 m	m ± 0.05 m	m		
400	0.0010 0.0012 0.0015 0.0018 0.0022 0.0027 0.0033 0.0039 0.0047 0.0056 0.0068	2.5 x 6.5 x 7.2	0.18	65 (2000)	66 (2000)	51 (2000)	52 (2000)	55 (1000)	56 (1000)	58 (2000)	59 (2000)	102 122 152 182 222 272 332 392 472 562 682 822
	0.010 0.012 0.015	3.5 x 8.0 x 7.2	0.30	65 (1500)	66 (1500)	51 (2000)	52 (2000)	55 (1000)	56 (1000)	58 (1500)	59 (1500)	103 123 153
	0.018 0.022 0.027	4.5 x 9.0 x 7.2	0.42	65 (1000)	66 (1000)	51 (2000)	52 (2000)	55 (1000)	56 (1000)	58 (1000)	59 (1000)	183 223 273
	0.033 0.039 0.047	6.0 x 11.0 x 7.2	0.64	65 (750)	66 (750)	51 (2000)	52 (2000)	55 (1000)	56 (1000)	58 (1000)	59 (1000)	333 393 473

Notes

- SPQ = Standard Packing Quantity
- (1) Weight for short lead product only



					C	ATALOG N	UMBER B	FC2 370 XX	(YYY AND	PACKAGIN	NG	
				AMMO	PACK		LOOSE	IN BOX		RE	EL	
U _{RDC}	CAP.	DIMENSIONS wxhxl	MASS	$P_0 = 12$	5.5 mm; 2.7 mm	SHORT	LEADS	LONG	LEADS			C-VALUE
(V)	(μ F)	(mm)	(g) ⁽¹⁾	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	
				XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	YYY
			U	_{RAC} = 40 V;	PITCH = 5	i.08 mm ± 0	0.30 mm; d	_t = 0.50 mr	n ± 0.05 mı	m		
	0.12											124
	0.15											154
	0.18	25 4 8 0 4 7 0	0.30	СВ	CC	CE	CF	СН	CI	CL	СМ	184
	0.22	3.5 x 8.0 x 7.2	0.30	(1500)	(1500)	(2000)	(2000)	(1000)	(1000)	(1500)	(1500)	224
100	0.27											274
	0.33											334
	0.39	45 × 0.0 × 7.0	0.40	СВ	CC	CE	CF	CH	CI	CL	СМ	394
	0.47	4.5 x 9.0 x 7.2	0.42	(1000)	(1000)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	474
	0.56	6.0 x 11.0 x 7.2	0.64	CB	CC	CE	CF	CH	CI	CL	СМ	564
	0.50	0.0 X 11.0 X 7.2	0.04	(750)	(750)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	304
	U _{RAC} = 63 V; PITCH = 5.08 mm ± 0.30 mm; d _t = 0.50 mm ± 0.05 mm											
	0.022	2.5 x 6.5 x 7.2	0.18	EB	EC	EE	EF	EH	El	EL	EM	223
	0.027	2.5 X 0.5 X 7.2	0.10	(2000)	(2000)	(2000)	(2000)	(1000)	(1000)	(2000)	(2000)	273
	0.033											333
	0.039			- FD	F0							393
	0.047	3.5 x 8.0 x 7.2	0.30	EB (1500)	EC (1500)	EE (2000)	EF (2000)	EH (1000)	EI (1000)	EL (1500)	EM (1500)	473
250	0.056			(,	(.555)	(2000)	(2000)	(,	(,	(,	(,	563
230	0.068											683
	0.082	4.5 x 9.0 x 7.2	0.42	EB	EC	EE	EF	EH	El	EL	EM	823
	0.10	4.5 X 9.0 X 7.2	0.42	(1000)	(1000)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	104
	0.12											124
	0.15	0011.070	0.64	EB	EC	EE	EF	EH	El	EL	EM	154
	0.18	6.0 x 11.0 x 7.2	0.64	(750)	(750)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	184
	0.22											224
			U _F	RAC = 160 V	; PITCH =	5.08 mm ±	0.30 mm; c	d _t = 0.50 m	m ± 0.05 m	ım		
	0.010											103
	0.012	05 05 73	0.40	FB	FC	FE	FF	FH	Fl	FL	FM	123
	0.015	2.5 x 6.5 x 7.2	0.18	(2000)	(2000)	(2000)	(2000)	(1000)	(1000)	(2000)	(2000)	153
	0.018											183
	0.022		<u> </u>									223
4.5-	0.027			FB	FC	FE	FF	FH	Fl	FL	FM	273
400	0.033	3.5 x 8.0 x 7.2	0.30	(1500)	(1500)	(2000)	(2000)	(1000)	(1000)	(1500)	(1500)	333
	0.039											393
	0.047			FB	EC	FE	FF	FH	Fl	FL	FM	473
	0.056	4.5 x 9.0 x 7.2	0.42	(1000)	FC (1000)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	563
	0.068			,	,,	(/	,,	, , , ,	(/	,	,,	683
	0.082	6.0 x 11.0 x 7.2	0.64	FB	FC	FE	FF	FH	Fl	FL	FM	823
	0.002	0.0 x 11.0 x 7.2	0.04	(750)	(750)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	104
	0.10			J	l	<u> </u>	<u> </u>	<u> </u>			1	104



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Vishay BCcomponents

					C	ATALOG N	UMBER BI	FC2 370 XX	(YYY AND	PACKAGIN	NG		
				AMMC	PACK		LOOSE IN BOX			REEL			
U _{RDC}	CAP.	DIMENSIONS wxhxl	MASS		.5 mm; 2.7 mm	SHORT	LEADS	LONG	LEADS			C-VALUE	
(V)	(μF)	(mm)	(g) ⁽¹⁾	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %		
				XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	YYY	
			U _F	RAC = 220 V	; PITCH =	5.08 mm ±	0.30 mm; c	l _t = 0.50 m	m ± 0.05 m	m			
	0.00068											681	
	0.00082											821	
	0.0010											102	
	0.0012											122	
	0.0015											152	
	0.0018											182	
	0.0020											202	
	0.0022				GB (1500)							222	
	0.0024	3.5 x 8.0 x 7.2	0.35	GB (1500)		GE (2000)	GF (2000)	GH (1000)	GI (1000)	GL (1500)	GM (1500)	242	
	0.0027			(1222)		(1223)	(====)	(====)	(1223)		, , ,	(1117)	272
630	0.0033										332		
630	0.0039											392	
	0.0047											472	
	0.0056											562	
	0.0068											682	
	0.0082											822	
	0.010											103	
	0.012	4.5 x 9.0 x 7.2	0.45	GB	GC	GE	GF	GH	GI	GL	GM	123	
	0.015	4.5 x 3.0 x 7.2	0.43	(1000)	(1000)	(2000)	(2000)	(1000)	(1000)	(1000)	(1000)	153	
	0.018											183	
	0.022	6.0 x 11.0 x 7.2	0.65	GB	GC	GE	GF	GH	GI	GL	GM	223	
	0.027	0.0 x 11.0 x 7.2	0.03	(750)	(750)	(2000)	(2000)	(1000)		(1000)	(1000)	273	
	0.033											333	

Notes

[•] SPQ = Standard Packing Quantity

⁽¹⁾ Weight for short lead product only

MOUNTING

Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

For detailed tape specifications refer to packaging information: www.vishay.com/doc?28139 or end of catalog.

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that stand-off pips are in good contact with the printed-circuit board:

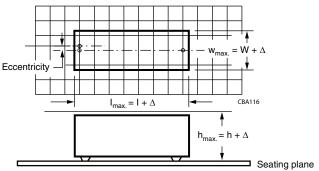
- \bullet For pitches \leq 15 mm capacitors shall be mechanically fixed by the leads
- · For larger pitches the capacitors shall be mounted in the same way and the body clamped

Space Requirements on Printed Circuit Board

The maximum space for length ($l_{max.}$), width ($w_{max.}$) and height ($h_{max.}$) of film capacitors to take in account on the printed circuit board is shown in the drawings.

• For products with pitch \leq 15 mm, $\Delta w = \Delta l = 0.3$ mm; $\Delta h = 0.1$ mm

Eccentricity defined as in drawing. The maximum eccentricity is smaller than or equal to the lead diameter of the product concerned.



SOLDERING CONDITIONS

For general soldering conditions and wave soldering profile, we refer to the application note:

"Soldering Guidelines for Film Capacitors": www.vishay.com/doc?28171

Storage Temperature

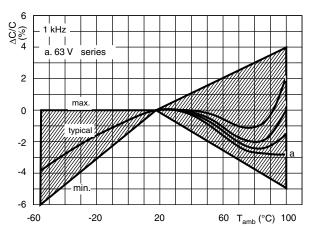
T_{sta} = -25 °C to +35 °C with with relative humidity of maximum 75 % without condensation

Ratings and Characteristics Reference Conditions

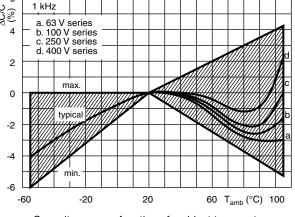
Unless otherwise specified, all electrical values apply to an ambient temperature of 23 °C \pm 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

For reference testing, a conditioning period shall be applied over 96 h \pm 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.

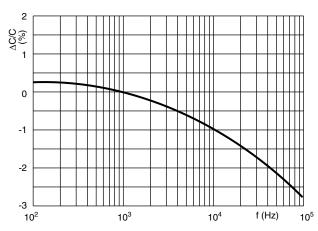




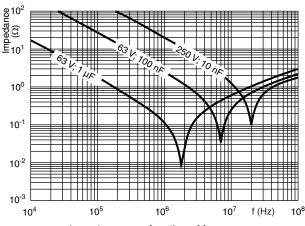
Capacitance as a function of ambient temperature (typical curve) for voltage 63 V



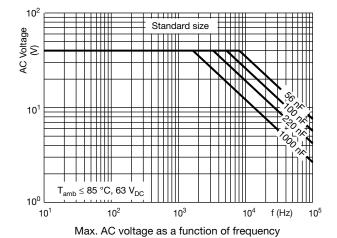
Capacitance as a function of ambient temperature (typical curve) for voltages > 63 V

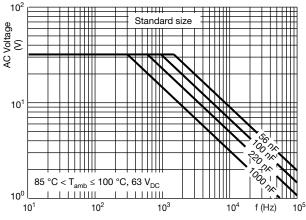


Capacitance as a function of frequency (typical curve)



Impedance as a function of frequency





Max. AC voltage as a function of frequency



10²

AC Voltage (V)

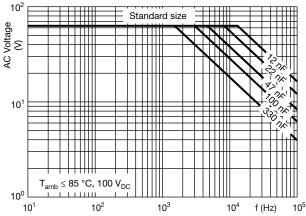
10¹

10⁰

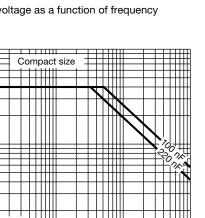
10¹

 $T_{amb} \le 85$ °C, 100 V_{DC}

10²



Max. AC voltage as a function of frequency

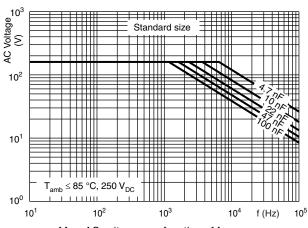


 10^4

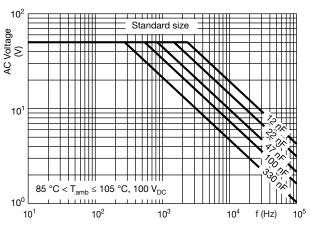
f (Hz)

10⁵

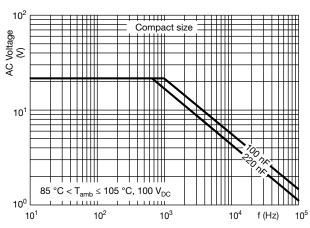
10³ Max. AC voltage as a function of frequency



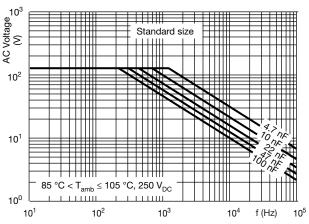
Max. AC voltage as a function of frequency



Max. AC voltage as a function of frequency

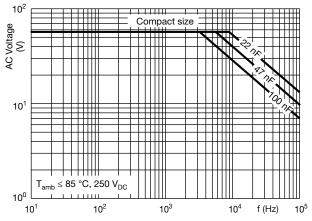


Max. AC voltage as a function of frequency

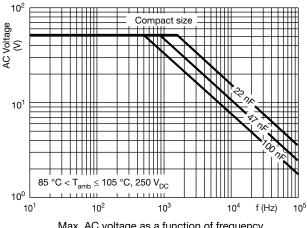


Max. AC voltage as a function of frequency

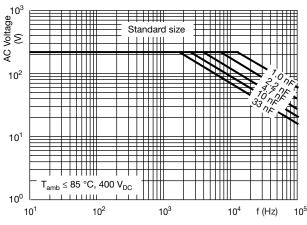




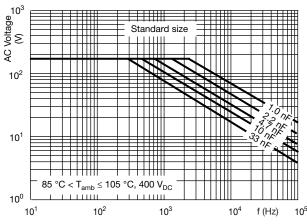
Max. AC voltage as a function of frequency



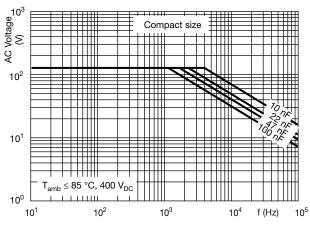
Max. AC voltage as a function of frequency



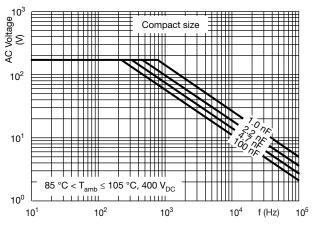
Max. AC voltage as a function of frequency



Max. AC voltage as a function of frequency

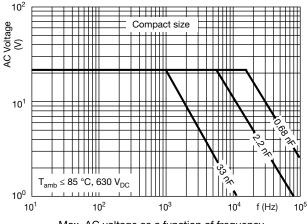


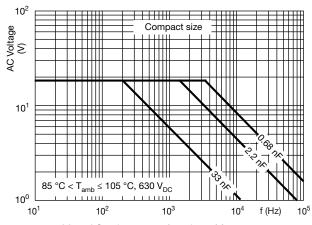
Max. AC voltage as a function of frequency



Max. AC voltage as a function of frequency







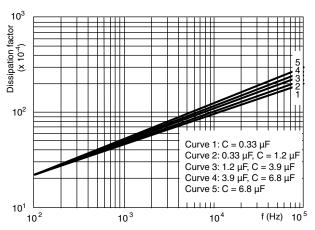
Max. AC voltage as a function of frequency

Max. AC voltage as a function of frequency

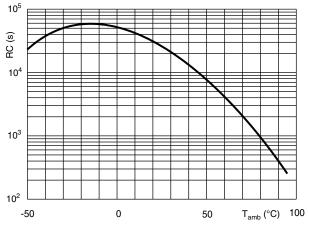
Maximum RMS current (sinewave) as a function of frequency

The maximum RMS current is defined by $I_{AC} = \omega \times C \times U_{AC}$.

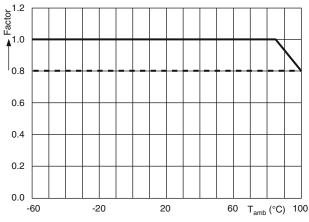
 U_{AC} is the maximum AC voltage depending on the ambient temperature in the curves "Max. RMS voltage and AC current as a function of frequency".



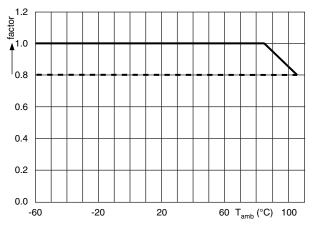
Tangent of loss angle as a function of frequency (typical curve)



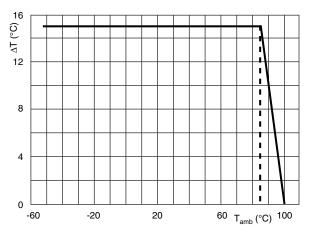
Insulation resistance as a function of the ambient temperature (typical curve)

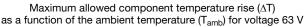


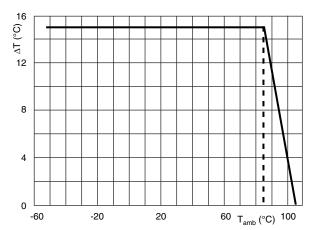
Max. DC and AC voltage as a function of frequency for voltage 63 V



Max. DC and AC voltage as a function of frequency for voltages > 63 V







Maximum allowed component temperature rise (ΔT) as a function of the ambient temperature (T_{amb}) for voltages > 63 V

HEAT CONDUCTIVITY (G) AS A FUNCTION OF (ORIGINAL) PITCH AND CAPACITOR BODY THICKNESS IN mW/°C						
W _{max.}	HEAT CONDUCTIVITY (mW/°C)					
(mm)	PITCH 5 mm					
2.5	2.5					
3.5	3.0					
4.5	4.0					
6.0	5.5					

POWER DISSIPATION AND MAXIMUM COMPONENT TEMPERATURE RISE

The power dissipation must be limited in order not to exceed the maximum allowed component temperature rise as a function of the free ambient temperature.

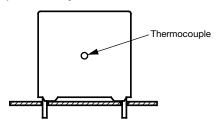
The power dissipation can be calculated according type detail specification "HQN-384-01/101: Technical Information Film Capacitors", www.vishay.com/doc?28147.

The component temperature rise (ΔT) can be measured (see section "Measuring the component temperature" for more details) or calculated by $\Delta T = P/G$:

- ΔT = component temperature rise (°C)
- P = power dissipation of the component (mW)
- G = heat conductivity of the component (mW/°C)

MEASURING THE COMPONENT TEMPERATURE

A thermocouple must be attached to the capacitor body as in:



The temperature is measured in unloaded (T_{amb}) and maximum loaded condition (T_C).

The temperature rise is given by $\Delta T = T_C - T_{amb}$.

To avoid radiation or convection, the capacitor should be tested in a wind-free box.

APPLICATION NOTE AND LIMITING CONDITIONS

These capacitors are not suitable for mains applications as across-the-line capacitors without additional protection, as described hereunder. These mains applications are strictly regulated in safety standards and therefore electromagnetic interference suppression capacitors conforming the standards must be used.

For capacitors connected in parallel, normally the proof voltage and possibly the rated voltage must be reduced. For information depending of the capacitance value and the number of parallel connections contact: dc-film@vishav.com

To select the capacitor for a certain application, the following conditions must be checked:

- 1. The peak voltage (U_P) shall not be greater than the rated DC voltage (U_{BDC})
- 2. The peak-to-peak voltage (U_{P-P}) shall not be greater than 2√2 x U_{BAC} to avoid the ionization inception level
- 3. The voltage peak slope (dU/dt) shall not exceed the rated voltage pulse slope in an RC-circuit at rated voltage and without ringing. If the pulse voltage is lower than the rated DC voltage, the rated voltage pulse slope may be multiplied by U_{RDC} and divided by the applied voltage.

For all other pulses following equation must be fulfilled:

$$2 \times \int_{0}^{1} \left(\frac{dU}{dt}\right)^{2} \times dt < U_{RDC} \times \left(\frac{dU}{dt}\right)_{rated}$$

T is the pulse duration.

- 4. The maximum component surface temperature rise must be lower than the limits (see figure max. allowed component temperature rise).
- 5. Since in circuits used at voltages over 280 V peak-to-peak the risk for an intrinsically active flammability after a capacitor breakdown (short circuit) increases, it is recommended that the power to the component is limited to 100 times the values mentioned in the table: "Heat conductivity"
- 6. When using these capacitors as across-the-line capacitor in the input filter for mains applications or as series connected with an impedance to the mains the applicant must guarantee that the following conditions are fulfilled in any case (spikes and surge voltages from the mains included).

VOLTAGE CONDITIONS FOR 6 ABOVE	VOLTAGE CONDITIONS FOR 6 ABOVE								
ALLOWED VOLTAGES	T /05°C	85 °C < T _{amb} ≤ 100 °C FOR 63 V							
ALLOWED VOLTAGES	T _{amb} ≤ 85 °C	85 °C < T _{amb} ≤ 105 °C FOR > 63 V							
Maximum continuous RMS voltage	U _{RAC}	See "Max. AC voltage as function of temperature CBB952" per characteristics							
Maximum temperature RMS-overvoltage (< 24 h)	1.25 x U _{RAC}	U _{RAC}							
Maximum peak voltage (V _{O-P}) (< 2 s)	1.6 x U _{RDC}	1.3 x U _{RDC}							

EXAMPLE

C = 330 nF - 63 V used for the voltage signal shown in next drawing.

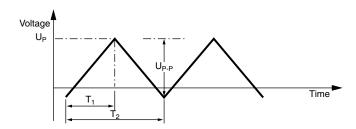
 $U_{P-P} = 40 \text{ V}$; $U_P = 35 \text{ V}$; $T_1 = 100 \text{ }\mu\text{s}$; $T_2 = 200 \text{ }\mu\text{s}$

The ambient temperature is 35 °C

Checking conditions:

- 1. The peak voltage $U_P = 35 \text{ V}$ is lower than 63 V_{DC}
- 2. The peak-to-peak voltage 40 V is lower than $2\sqrt{2}$ x 40 V_{AC} = 113 U_{P-P}
- 3. The voltage pulse slope (dU/dt) = 40 V/100 μs = 0.4 V/μs
 This is lower than 60 V/μs (see specific reference data for each version)
- 4. The dissipated power is 16.2 mW as calculated with fourier terms The temperature rise for W_{max.} = 3.5 mm and pitch = 5 mm will be 16.2 mW/3.0 mW/°C = 5.4 °C This is lower than 15 °C temperature rise at 35 °C, according figure max. allowed component temperature rise
- 5. Not applicable
- 6. Not applicable

Voltage Signal





INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-2 and Specific Reference Data".

SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1	- CONDITIONS	12.110111111111111111111111111111111111
4.1 Dimensions (detail)		As specified in chapters "MKT 370 General Data" of this specification
4.3.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 470 nF at 100 kHz or for C > 470 nF at 10 kHz	
4.3 Robustness of terminations	Tensile and bending	No visible damage
4.4 Resistance to soldering heat	Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s	
4.14 Component solvent resistance	Isopropylalcohol at room temperature Method: 2 Immersion time: 5 min ± 0.5 min Recovery time: min. 1 h, max. 2 h	
4.4.2 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 2$ % of the value measured initially
	Tangent of loss angle	Increase of tan δ ≤ 0.005 for: C ≤ 100 nF or ≤ 0.010 for: 100 nF < C ≤ 220 nF or ≤ 0.015 for: 220 nF < C ≤ 470 nF and ≤ 0.003 for: C > 470 nF Compared to values measured in 4.3.1
SUB-GROUP C1B OTHER PART OF SAMPLE OF SUB-GROUP C1		
4.6.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 470 nF at 100 kHz or for C > 470 nF at 10 kHz	
4.6 Rapid change of temperature	θA = -55 °C θB = +100 °C for rated voltage 63 V +105 °C for rated voltage > 63 V 5 cycles Duration t = 30 min	
4.7 Vibration	Visual examination Mounting: see section "Mounting" of this specification Procedure B4 Frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or Acceleration 98 m/s² (whichever is less severe) Total duration 6 h	No visible damage
4.7.2 Final inspection	Visual examination	No visible damage



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	UP C INSPECTION REQ	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-CLAUSE NUMBER AND TEST SUB-GROUP C1B OTHER PART OF SAMPLE OF SUB-GROUP C1		CONDITIONS	FERI CHIMANOE REQUIREMENTS
4.9	Shock	Mounting: see section "Mounting" of this specification Pulse shape: half sine Acceleration: 490 m/s² Duration of pulse: 11 ms	
4.9.3	Final measurements	Visual examination	No visible damage
		Capacitance	$ \Delta C/C \le 3$ % of the value measured in 4.6.
		Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.010 for: $C \leq 220$ nF or ≤ 0.015 for: 220 nF < $C \leq 470$ nF and ≤ 0.003 for: $C > 470$ nF Compared to values measured in 4.6.1
		Insulation resistance	As specified in section "Specific Reference Data 370" of this specification
SUB-GROUP C1 COMBINED SAMPLE OF SPECIMENS OF SUB-GROUPS C1A AND C1B			
4.10	Climatic sequence		
4.10.2	Dry heat	Temperature: +100 °C for rated voltage 63 V +105 °C for rated voltage > 63 V Duration: 16 h	
4.10.3	Damp heat cyclic Test Db, first cycle		
4.10.4	Cold	Temperature: -55 °C Duration: 2 h	
4.10.6	Damp heat cyclic Test Db, remaining cycles	Voltage proof = U _{RDC} for 1 min within 15 min after removal from testchamber	No breakdown of flash-over
4.10.6.2	2 Final measurements	Visual examination	No visible damage Legible marking
		Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.4.2 or 4.9.3
		Tangent of loss angle	Increase of $\tan \delta$ ≤ 0.010 for: $C \leq 220$ nF or ≤ 0.015 for: 220 nF $< C \leq 470$ nF and ≤ 0.005 for: $C > 470$ nF Compared to values measured in 4.3.1 or $4.6.1$
		Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this specification
SUB-G	ROUP C2		
4.11	Damp heat steady state	56 days, 40 °C, 90 % to 95 % RH	
4.11.1	Initial measurements	Capacitance Tangent of loss angle at 1 kHz	



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SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C2	- Constitution	1 2.11 01.111 11.10 11.20 11.20 11.211.211.10
4.11.3 Final measurements	Voltage proof = U _{RDC} for 1 min within 15 min after removal from testchamber	No breakdown of flash-over
	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.11
	Tangent of loss angle	Increase of tan $\delta \le 0.005$ Compared to values measured in 4.11.1
	Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this specification
SUB-GROUP C3		
4.12 Endurance	Duration: 2000 h 1.25 x U _{RDC} at 85 °C 0.8 x 1.25 U _{RDC} at +100 °C for rated voltage 63 V 0.8 x 1.25 U _{RDC} at +105 °C for rated voltage > 63 V	
4.12.1 Initial measurements	Capacitance Tangent of loss angle: For C ≤ 470 nF at 100 kHz or for C > 470 nF at 10 kHz	
4.12.5 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 5$ % compared to values measure in 4.12.1
	Tangent of loss angle	Increase of tan δ ≤ 0.005 for at 85 °C ≤ 0.010 for at 100 °C for: C \leq 220 nF or ≤ 0.015 for: 220 nF < C \leq 470 nF and ≤ 0.003 for: C > 470 nF Compared to values measured in 4.12.1
	Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this specification
SUB-GROUP C4		
4.13 Charge and discharge	10 000 cycles Charged to U_{RDC} Discharge resistance: $R = \frac{U_R}{C \times (2.5 \times (dU/dt)_R)}$	
4.13.1 Initial measurements	Capacitance Tangent of loss angle: For C ≤ 470 nF at 100 kHz or for C > 470 nF at 10 kHz	
4.13.3 Final measurements	Capacitance	$ \Delta C/C \le 3$ % compared to values measure in 4.13.1
	Tangent of loss angle	$\begin{array}{l} \text{Increase of tan } \delta \\ \leq 0.005 \text{ for: } C \leq 100 \text{ nF or} \\ \leq 0.010 \text{ for: } 100 \text{ nF < C} \leq 220 \text{ nF or} \\ \leq 0.015 \text{ for: } 220 \text{ nF < C} \leq 470 \text{ nF and} \\ \leq 0.003 \text{ for: } C > 470 \text{ nF} \\ \text{Compared to values measured in } 4.13.1 \end{array}$
	Insulation resistance	≥50 % of values specified in section "Spec Reference Data 370" of this specification



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Revision: 13-Jun-16 1 Document Number: 91000